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INFORMATION DISCLOSURE STATEMENT STATEMENT BY APPLICANT		Applicant Kirk P. Seward et al	
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U.S. PATENT DOCUMENTS

FOREIGN PATENT DOCUMENTS

		Document Number	Date	Country	Class	Subclass	Translation YES	NO
01		JP9123330	Abstr.	Japan				
02		JP9109320	Abstr.	Japan				
03		JP8199080	Abstr.	Japan				
04		JP7290571	Abstr.	Japan				
05		JP3059142	Abstr.	Japan				
06		JP3023379	Abstr.	Japan				

OTHER DISCLOSURES (including Author, Title, Date, Pertinent Pages, Place of Publication, Etc.)

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1. H. Tobushi et al, Journal of Intelligent Materials Systems and Structure, Vol. 8, Aug. 1007, pp. 711-718.
2. G. Bourbon et al, SPIE-Int. Soc. Opt. Eng. 1998, pp. 147-158
3. H. Tobushi et al, JSME International Journal, Series 1, Vol. 35, No. 3, 1992
4. P. Krulevitch, Journal of Microelectromechanical Systems, Vol. 5, No. 4, Dec. 1996, pp. 270-282.

Examiner

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7/11/02

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